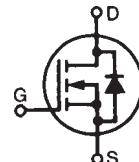


# PolarHT™ Power MOSFET

## IXTQ 150N06P

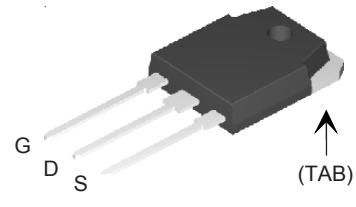
**V<sub>DSS</sub>** = 60 V  
**I<sub>D25</sub>** = 150 A  
**R<sub>DS(on)</sub>** ≤ 10 mΩ

N-Channel Enhancement Mode  
Avalanche Rated



| Symbol                  | Test Conditions   | Maximum Ratings |           |      |
|-------------------------|---|-----------------|-----------|------|
| <b>V<sub>DSS</sub></b>  | T <sub>J</sub> = 25°C to 175°C  | 60              |           | V    |
| <b>V<sub>DGR</sub></b>  | T <sub>J</sub> = 25°C to 175°C; R <sub>GS</sub> = 1 MΩ  | 60              |           | V    |
| <b>V<sub>GS</sub></b>   | Continuous  | ±20             |           | V    |
| <b>V<sub>GSM</sub></b>  | Transient   | ±30             |           | V    |
| <b>I<sub>D25</sub></b>  | T <sub>C</sub> = 25°C   | 150             |           | A    |
| <b>I<sub>DRMS</sub></b> | External lead current limit   | 75              |           | A    |
| <b>I<sub>DM</sub></b>   | T <sub>C</sub> = 25°C, pulse width limited by T <sub>JM</sub>   | 280             |           | A    |
| <b>I<sub>AR</sub></b>   | T <sub>C</sub> = 25°C   | 60              |           | A    |
| <b>E<sub>AR</sub></b>   | T <sub>C</sub> = 25°C   | 60              |           | mJ   |
| <b>E<sub>AS</sub></b>   | T <sub>C</sub> = 25°C   | 2.5             |           | J    |
| <b>dv/dt</b>            | I <sub>S</sub> ≤ I <sub>DM</sub> , di/dt ≤ 100 A/μs, V <sub>DD</sub> ≤ V <sub>DSS</sub> , T <sub>J</sub> ≤ 150°C, R <sub>G</sub> = 10 Ω | 10              |           | V/ns |
| <b>P<sub>D</sub></b>    | T <sub>C</sub> = 25°C   | 480             |           | W    |
| <b>T<sub>J</sub></b>    |   | -55 ... +175    |           | °C   |
| <b>T<sub>JM</sub></b>   |   | 175             |           | °C   |
| <b>T<sub>stg</sub></b>  |   | -55 ... +150    |           | °C   |
| <b>T<sub>L</sub></b>    | 1.6 mm (0.062 in.) from case for 10 s   | 300             |           | °C   |
| <b>T<sub>SOLD</sub></b> | Plastic body for 10 s   | 260             |           | °C   |
| <b>M<sub>d</sub></b>    | Mounting torque   | 1.13/10         | Nm/lb.in. |      |
| <b>Weight</b>           |   | 5.5             |           | g    |

TO-3P (IXTQ)



G = Gate  
S = Source

D = Drain  
TAB = Drain

### Features

- International standard package
- Unclamped Inductive Switching (UIS) rated
- Low package inductance
  - easy to drive and to protect

### Advantages

- Easy to mount
- Space savings
- High power density

| Symbol                    | Test Conditions<br>(T <sub>J</sub> = 25°C, unless otherwise specified)                                      | Characteristic Values |           |      |
|---------------------------|---|-----------------------|-----------|------|
|                           |   | Min.                  | Typ.      | Max. |
| <b>BV<sub>DSS</sub></b>   | V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA  | 60                    |           | V    |
| <b>V<sub>GS(th)</sub></b> | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA   | 2.5                   |           | V    |
| <b>I<sub>GSS</sub></b>    | V <sub>GS</sub> = ±20 V <sub>DC</sub> , V <sub>DS</sub> = 0   |                       | ±100      | nA   |
| <b>I<sub>DSS</sub></b>    | V <sub>DS</sub> = V <sub>DSS</sub><br>V <sub>GS</sub> = 0 V   |                       | 25<br>250 | μA   |
| <b>R<sub>DS(on)</sub></b> | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 0.5 I <sub>D25</sub><br>Pulse test, t ≤ 300 μs, duty cycle d ≤ 2 % | 8                     | 10        | mΩ   |

| Symbol  | Test Conditions  | Characteristic Values |      |                             |
|---|--|-----------------------|------|-----------------------------|
|   |  | Min.                  | Typ. | Max.                        |
| $g_{fs}$                                      | $V_{DS} = 10 \text{ V}; I_D = 0.5 I_{D25}$ , pulse test                                      | 32                    | 50   | S                           |
| $C_{iss}$<br>$C_{oss}$<br>$C_{rss}$           | $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$                             | 3000                  | pF   |                             |
|   |  | 2100                  | pF   |                             |
|   |  | 850                   | pF   |                             |
| $t_{d(on)}$<br>$t_r$<br>$t_{d(off)}$<br>$t_f$ | $V_{GS} = 10 \text{ V}, V_{DS} = 0.5 V_{DSS}, I_D = I_{D25}$<br>$R_G = 10 \Omega$ (External) | 27                    | ns   |                             |
|   |  | 53                    | ns   |                             |
|   |  | 66                    | ns   |                             |
|   |  | 45                    | ns   |                             |
| $Q_{g(on)}$<br>$Q_{gs}$<br>$Q_{gd}$           | $V_{GS} = 10 \text{ V}, V_{DS} = 0.5 V_{DSS}, I_D = 0.5 I_{D25}$                             | 118                   | nC   |                             |
|   |  | 30                    | nC   |                             |
|   |  | 55                    | nC   |                             |
| $R_{thJC}$                                    |  |                       | 0.31 | $^{\circ}\text{C}/\text{W}$ |
| $R_{thCS}$                                    |  | 0.21                  |      | $^{\circ}\text{C}/\text{W}$ |

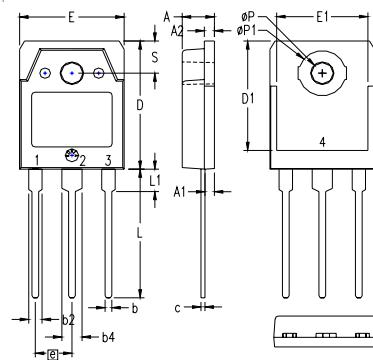
## Source-Drain Diode

## Characteristic Values

(T<sub>J</sub> = 25°C, unless otherwise specified)

| Symbol               | Test Conditions  | Min. | Typ. | Max.  |
|----------------------|--|------|------|-------|
| $I_s$                | $V_{GS} = 0 \text{ V}$   |      |      | 150 A |
| $I_{SM}$             | Repetitive   |      |      | 280 A |
| $V_{SD}$             | $I_F = I_s, V_{GS} = 0 \text{ V}$ ,<br>Pulse test, t ≤ 300 μs, duty cycle d ≤ 2 %                      |      |      | 1.5 V |
| $t_{rr}$<br>$Q_{RM}$ | $I_F = 25 \text{ A}, -di/dt = 100 \text{ A}/\mu\text{s}$<br>$V_R = 30 \text{ V}, V_{GS} = 0 \text{ V}$ | 90   | ns   |       |
|                      |  | 2.0  | μC   |       |

## TO-3P (IXTQ) Outline



1 – GATE  
2 – DRAIN (COLLECTOR)  
3 – SOURCE (EMITTER)  
4 – DRAIN (COLLECTOR)

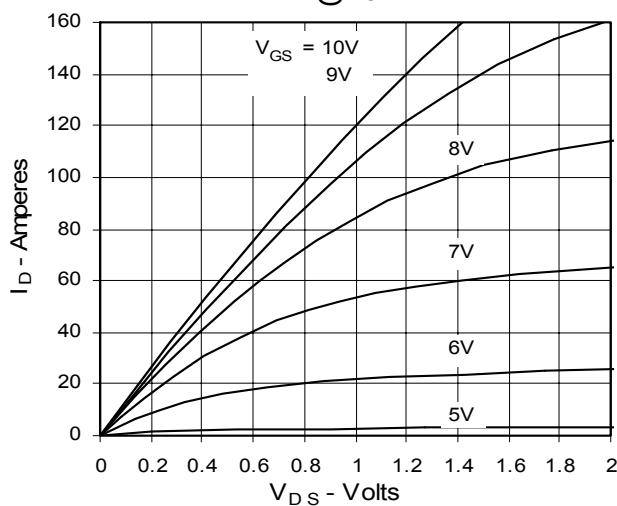
| SYM | INCHES   |      | MILLIMETERS |       |
|-----|----------|------|-------------|-------|
|     | MIN      | MAX  | MIN         | MAX   |
| A   | .185     | .193 | 4.70        | 4.90  |
| A1  | .051     | .059 | 1.30        | 1.50  |
| A2  | .057     | .065 | 1.45        | 1.65  |
| b   | .035     | .045 | 0.90        | 1.15  |
| b2  | .075     | .087 | 1.90        | 2.20  |
| b4  | .114     | .126 | 2.90        | 3.20  |
| c   | .022     | .031 | 0.55        | 0.80  |
| D   | .780     | .799 | 19.80       | 20.30 |
| D1  | .665     | .677 | 16.90       | 17.20 |
| E   | .610     | .622 | 15.50       | 15.80 |
| E1  | .531     | .539 | 13.50       | 13.70 |
| e   | .215 BSC |      | 5.45 BSC    |       |
| L   | .779     | .795 | 19.80       | 20.20 |
| L1  | .134     | .142 | 3.40        | 3.60  |
| φP  | .126     | .134 | 3.20        | 3.40  |
| φP1 | .272     | .280 | 6.90        | 7.10  |
| S   | .193     | .201 | 4.90        | 5.10  |

IXYS reserves the right to change limits, test conditions, and dimensions.

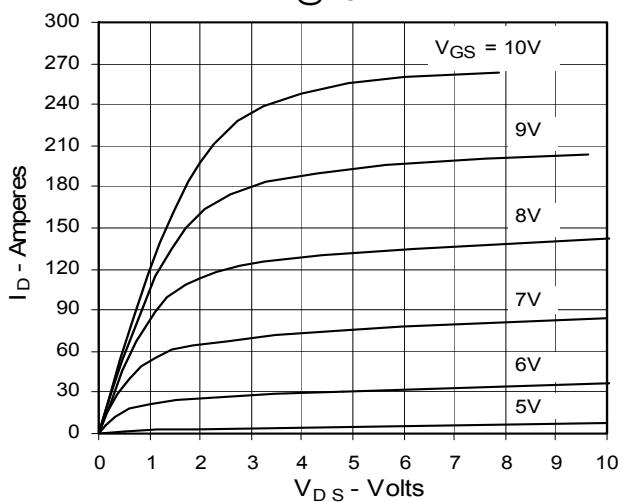
IXYS MOSFETs and IGBTs are covered by 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 one or more of the following U.S. patents: 4,850,072 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405B2 6,759,692 4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2

**Fig. 1. Output Characteristics**

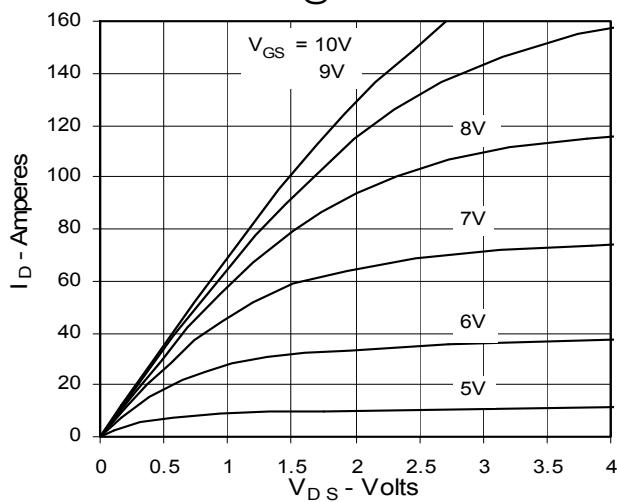
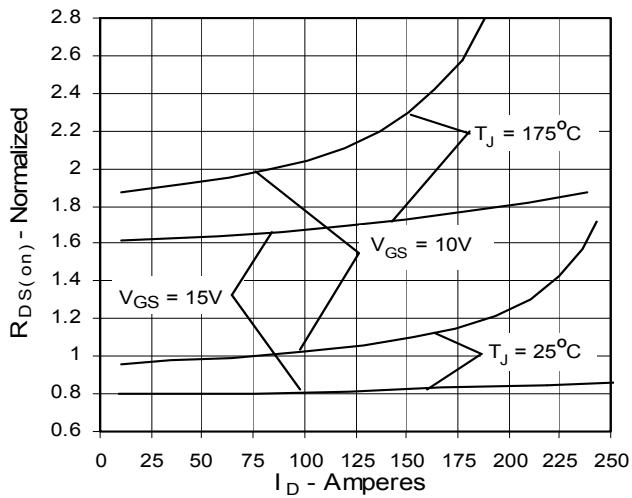
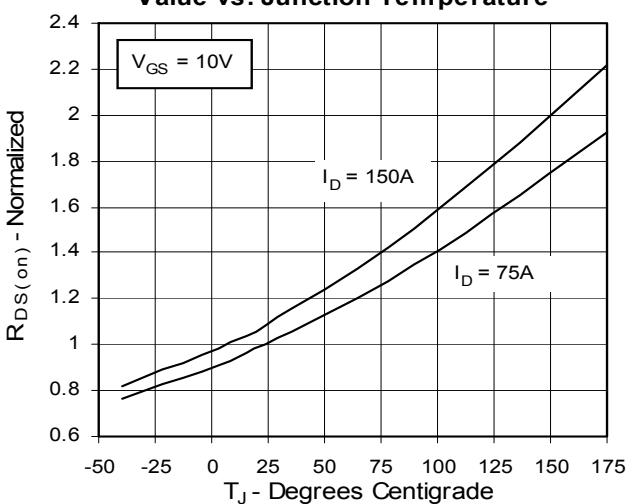
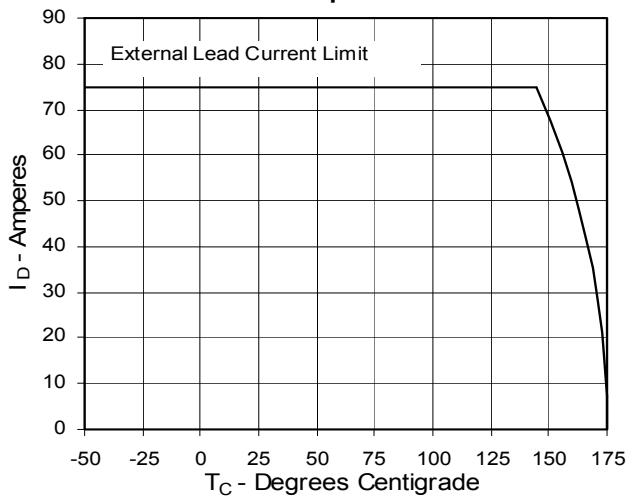
@ 25°C

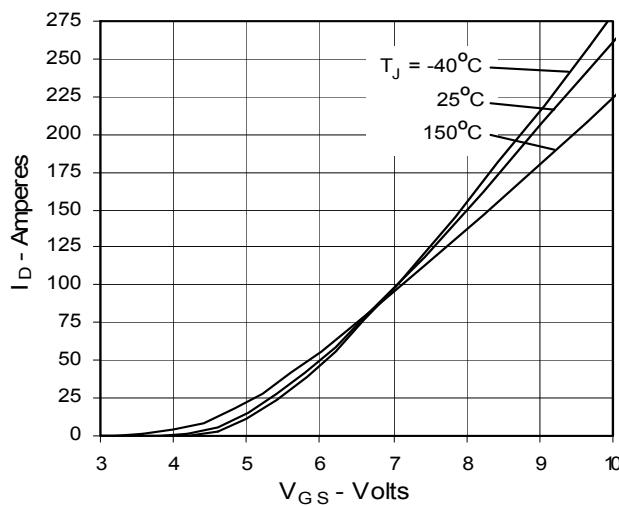
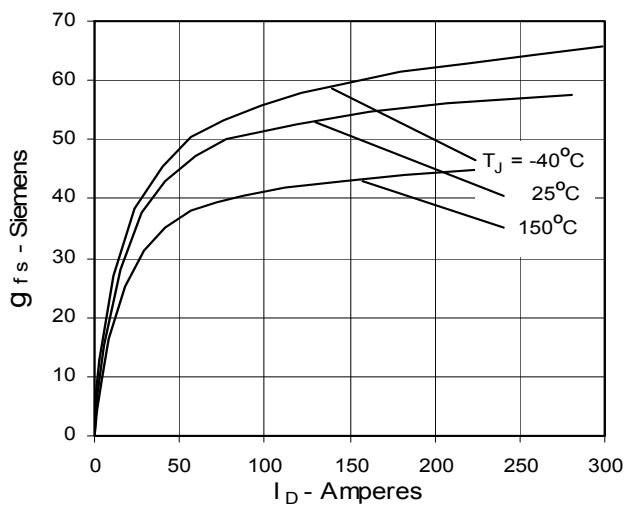
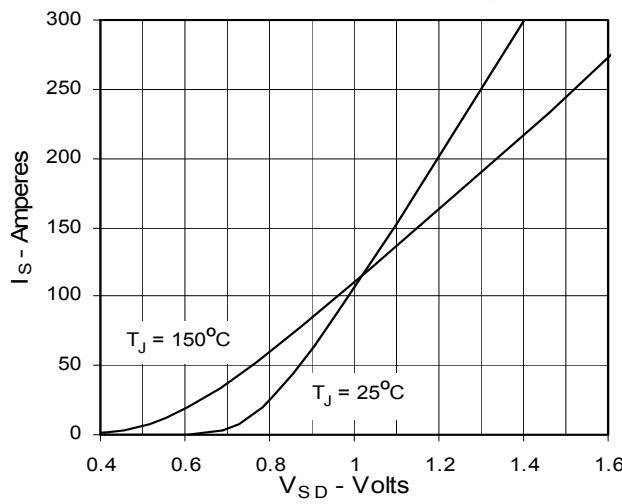
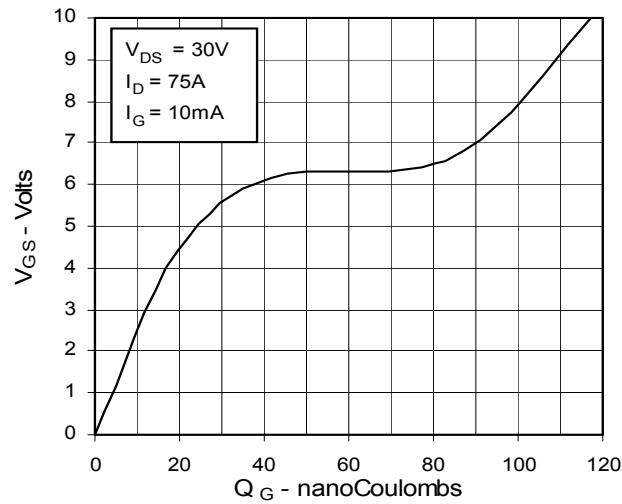
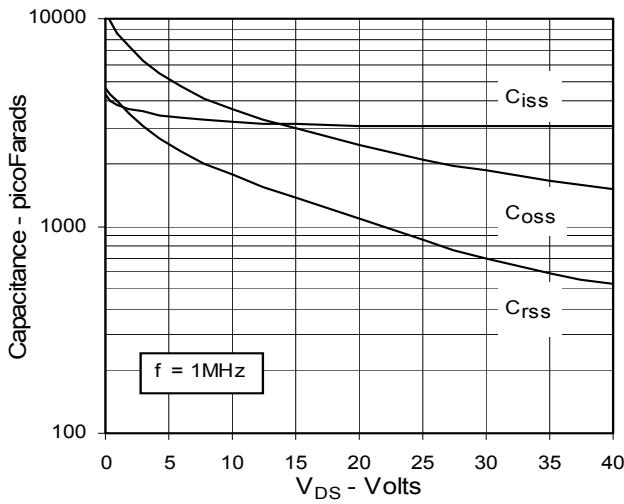
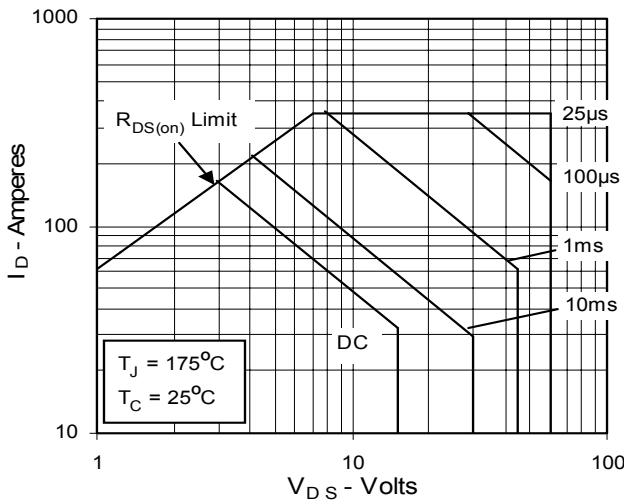
**Fig. 2. Extended Output Characteristics**

@ 25°C

**Fig. 3. Output Characteristics**

@ 150°C

**Fig. 5.  $R_{DS(on)}$  Normalized to 0.5  $I_{D25}$  Value vs. Drain Current****Fig. 4.  $R_{DS(on)}$  Normalized to 0.5  $I_{D25}$  Value vs. Junction Temperature****Fig. 6. Drain Current vs. Case Temperature**

**Fig. 7. Input Admittance**

**Fig. 8. Transconductance**

**Fig. 9. Source Current vs. Source-To-Drain Voltage**

**Fig. 10. Gate Charge**

**Fig. 11. Capacitance**

**Fig. 12. Forward-Bias Safe Operating Area**


**Fig. 13. Maximum Transient Thermal Resistance**